

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10575492
<b>Filing Date:</b>	12-Apr-2006
<b>Title of Invention:</b>	Method for forming wiring, method for manufacturing thin film transistor and droplet discharging method
<b>First Named Inventor/Applicant Name:</b>	Shinji Maekawa
<b>Filer:</b>	Anthony J. Canning/Chris Acuff
<b>Attorney Docket Number:</b>	740756-2947

Filed as Large Entity

### **U.S. National Stage under 35 USC 371 Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	1615	2	52	104
Independent claims in excess of 3	1614	1	220	220

### **Miscellaneous-Filing:**

#### **Petition:**

#### **Patent-Appeals-and-Interference:**

#### **Post-Allowance-and-Post-Issuance:**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	810	810
<b>Total in USD (\$)</b>				<b>1134</b>